

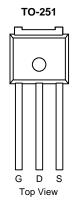
N-Channel 60 V (D-S) 175 °C MOSFET

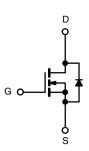
| PRODUCT SUMMARY | | | | |
|--|--------|--|--|--|
| V _{DS} (V) | 60 | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$ | 0.006 | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$ | 0.009 | | | |
| I _D (A) | 70 | | | |
| Configuration | Single | | | |

FEATURES

- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance
- \bullet 100 % R_g and UIS Tested







N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | |
|--|-------------------------|-----------------------------------|---------------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | V_{DS} | 60 | | |
| Gate-Source Voltage | | V_{GS} | ± 20 | V | |
| Continuous Drain Current | T _C = 25 °C | - I _D | 70 | | |
| | T _C = 125 °C | | 56 | | |
| Continuous Source Current (Diode Conduction) ^a | | Is | 100 | А | |
| Pulsed Drain Current ^b | | I _{DM} | 290 | | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 75 | | |
| Single Pulse Avalanche Energy | | E _{AS} | 101 | mJ | |
| Maximum Power Dissipation ^b | T _C = 25 °C | - P _D | 136 | W | |
| | T _C = 125 °C | | 45 | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to + 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------|------------------------|------------|-------|-------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Junction-to-Ambient | PCB Mount ^c | R_{thJA} | 50 | °C/W | |
| Junction-to-Case (Drain) | | R_{thJC} | 1.1 | C/ VV | |

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

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| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT | |
|---|--------------------------|--|---|------|------|-------|------|--|
| Static | 1 | | | I. | ı | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 60 | - | - | V | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | | 2.0 | 2.5 | V | |
| Gate-Source Leakage | I _{GSS} | V _{DS} = | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | - | ± 100 | nA | |
| | | V _{GS} = 0 V | V _{DS} = 60 V | =. | - | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V | V _{DS} = 60 V, T _J = 125 °C | =. | - | 50 | μΑ | |
| | | V _{GS} = 0 V | V _{DS} = 60 V, T _J = 175 °C | - | - | 150 | | |
| On-State Drain Current ^a | I _{D(on)} | V _{GS} = 10 V | V _{DS} ≥ 5 V | 50 | - | - | Α | |
| | | V _{GS} = 10 V | I _D = 25 A | - | - | 0.006 | Ω | |
| Dunin Course On Otata Basistanas | | V _{GS} = 10 V | I _D = 25 A, T _J = 125 °C | - | - | 0.017 | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V | I _D = 25 A, T _J = 175 °C | - | - | 0.049 | | |
| | | V _{GS} = 4.5 V | I _D = 20 A | - | - | 0.009 | | |
| Forward Transconductanceb | 9 _{fs} | V _{DS} = 15 V, I _D = 25 A | | - | 177 | - | S | |
| Dynamic ^b | | | | | | | | |
| Input Capacitance | C _{iss} | | | - | 4844 | 6060 | | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V$ | V _{DS} = 25 V, f = 1 MHz | - | 441 | 555 | pF | |
| Reverse Transfer Capacitance | C _{rss} | 1 | | - | 200 | 250 | | |
| Total Gate Charge ^c | Qg | | | - | 82 | 125 | | |
| Gate-Source Charge ^c | Q _{gs} | V _{GS} = 10 V | $V_{DS} = 30 \text{ V}, I_{D} = 50 \text{ A}$ | - | 14.5 | - | nC | |
| Gate-Drain Charge ^c | Q _{gd} | 1 | | - | 13.5 | - | | |
| Gate Resistance | R_g | f = 1 MHz | | 1 | 2 | 3 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | V_{DD} = 30 V, R_L = 0.6 Ω I_D \cong 50 A, V_{GEN} = 10 V, R_g = 1 Ω | | - | 14 | 21 | | |
| Rise Time ^c | t _r | | | - | 5 | 8 | - ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | | | - | 41 | 62 | | |
| Fall Time ^c | t _f | | | - | 7 | 11 | | |
| Source-Drain Diode Ratings and Char- | acteristics ^b | | | | | | | |
| Pulsed Current ^a | I _{SM} | | | - | - | 290 | Α | |
| Forward Voltage | V _{SD} | I _F = 50 A, V _{GS} = 0 V | | - | 0.9 | 1.5 | V | |

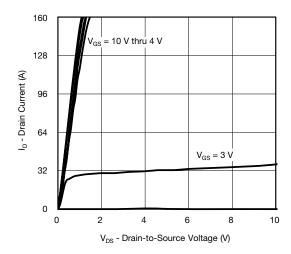
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

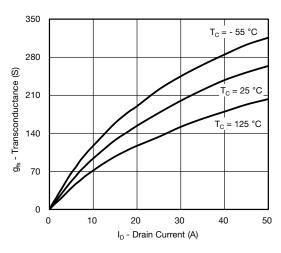
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



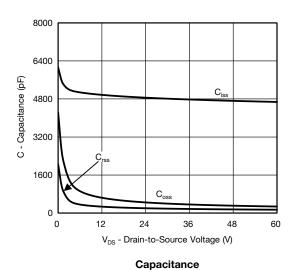
TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}C$, unless otherwise noted)

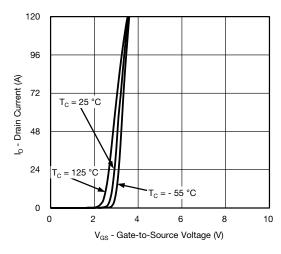


Output Characteristics

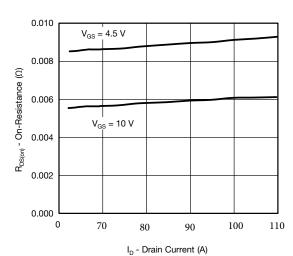


Transconductance

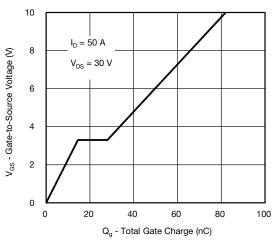




Transfer Characteristics



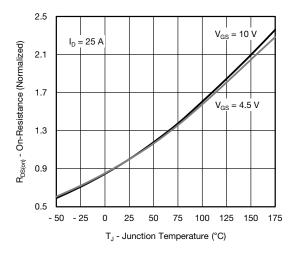
On-Resistance vs. Drain Current



Gate Charge



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



- 50 - 25 0 25 50 75 100 125 150 175 T_J - Junction Temperature (°C)

80

76

72

68

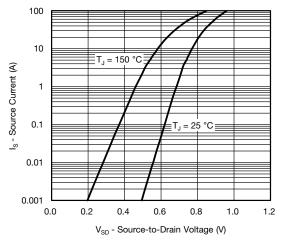
64

60

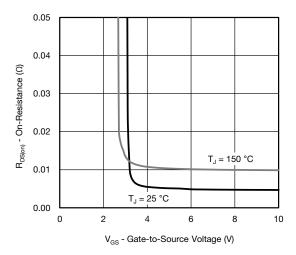
V_{DS} - Drain-to-Source Voltage (V)

 $I_D = 1 \text{ mA}$

On-Resistance vs. Junction Temperature

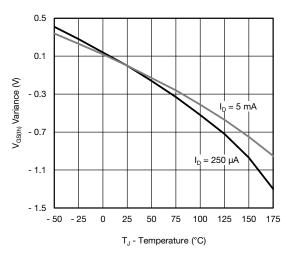


Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage

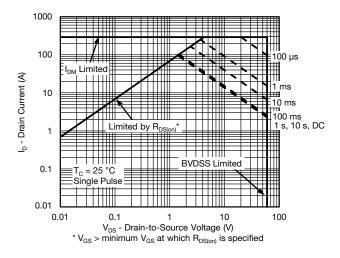
On-Resistance vs. Gate-to-Source Voltage



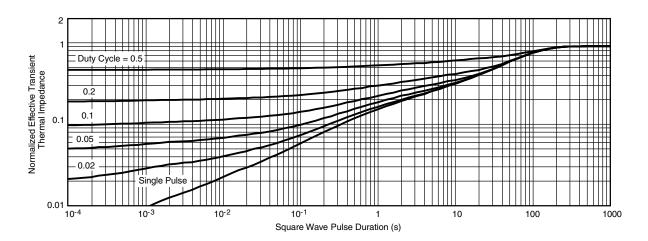
Threshold Voltage



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area

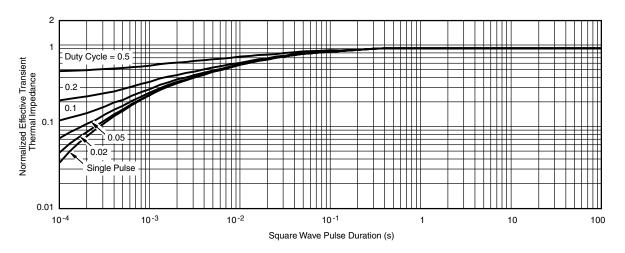


Normalized Thermal Transient Impedance, Junction-to-Ambient

5



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

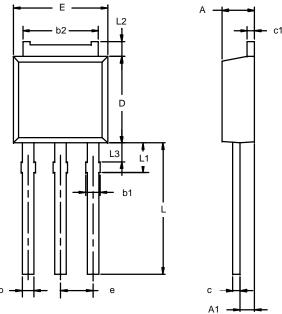
Note

- The characteristics shown in the two graphs
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



TO-251AA



| | A1 |
|-------|-------------------------------------|
| | |
| Note: | Dimension L3 is for reference only. |

| | MILLIM | IETERS | INC | HES |
|-----|--------|--------|-------|-------|
| Dim | Min | Max | Min | Max |
| Α | 2.21 | 2.38 | 0.087 | 0.094 |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 |
| b | 0.71 | 0.89 | 0.028 | 0.035 |
| b1 | 0.76 | 1.14 | 0.030 | 0.045 |
| b2 | 5.23 | 5.43 | 0.206 | 0.214 |
| С | 0.46 | 0.58 | 0.018 | 0.023 |
| с1 | 0.46 | 0.58 | 0.018 | 0.023 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |
| E | 6.48 | 6.73 | 0.255 | 0.265 |
| е | 2.28 | BSC | 0.090 | BSC |
| L | 3.89 | 9.53 | 0.153 | 0.375 |
| L1 | 1.91 | 2.28 | 0.075 | 0.090 |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 |
| L3 | 1.15 | 1.52 | 0.045 | 0.060 |



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